



A1	GND	B12	GND
A2	SSTXP1	B11	SSRXP1
A3	SSTXN1	B10	SSRXN1
A4	VBUS	B9	VBUS
A5	CC1	B8	SBU2
A6	DP1	B7	DN2
A7	DN1	B6	DP2
A8	SBU1	B5	CC2
A9	VBUS	B4	VBUS
A10	SSRXN2	B3	SSTXN2
A11	SSRXP2	B2	SSTXP2
A12	GND	B1	GND
IN	SIGNAL NAME	PIN	SIGNAL NA

Material
Housing Material: High temperature thermoplastic
Contact Terminal: High Grade Copper Alloy
Metallic Shell: Stainless Steel
Inner Ground Cover Shell: Stainless Steel
Mid Plate: Stainless Steel
Plating
Data Contact
Underplating: 50 μ " Min. Nickel
Contact Plating: 1 μ " Gold
Solder Area: 80 μ " Matte Tin
Shell
Metallic Shell: 50 μ " Min. Nickel
Cover Shell
Metallic Shell: 80 μ " Min. Nickel
Inner Ground Cover Shell
Metallic Shell: 50 μ " Min. Nickel
Electrical
Voltage Rating: 20V DC
Current Rating: Vbus pins collectively 5.00A, GND pins collectively 6.25A, B5 pin 1.25A, Other pins 0.25A per pin.
Contact Resistance: 40m Ω Max.
Insulation resistance: 100 M Ω MIN.
Dielectric withstanding voltage: 100V AC/Minute
Mechanical
Durability: 10,000 cycles
Mating Force: 5 to 20N
Unmating Force: 8 to 20N (post test)

U262-24XN-4BV60

- 1Au 1U'
- 2Au 3U'
- 5Au 15U'
- 6Au 30U'
- W: WHITE
- B: BLACK
- 1PBT
- 2PA6T
- 3PA9T
- 4LCP

					ANGLAR	$\pm 5^\circ$	DSND		DATE		SCALE: N/A	MODEL TYPE: 3.1 TYPE C		
					$L \leq 4$	± 0.2	DWN		DATE		VIEW:	PART NO.:		
					$4 < L \leq 16$	± 0.3	CHKD		DATE		UNIT: mm	DWG NO.:		
					$16 < L \leq 63$	± 0.4	APPD		DATE		SIZE: A4	U262-24XN-4BV60		
					$L > 63$	± 0.5						WEIGHT	SHEET	REVISION
					UNSPECIFIED TOLERANCES		Kosod Technology Co., Ltd.					1.0g	1/1	A0
MARK	DESCRIPTION	REVISIONS	DATE	REVISED	APPROVED									
	www.bodongkaiguan.net	www.ksdkg.com												